

VL400-EMITTER

TECHNICAL DATA

High Power UV LED, Emitter

Features

- Zener diode is built in the protective circuit against static electricity
- Low Voltage DC Operated
- High Power Intensity
- Lambertian Radiation Pattern
- Instant light (less than 100ns)



Specifications (25°C)

Item	Symbol	Value	Unit
Absolute Maximum Ratings			
DC Forward Current	I _F	350	mA
Peak Pulse Forward Current *	I _{FP}	500	mA
Reverse Voltage	U _R	5	V
Power Dissipation	PD	1300	mW
Operating Temperature	T _{OP}	-40 +105	°C
Storage Temperature	T _{STG}	-40 +120	°C
Soldering Temperature (for 5 sec.)	T _{SOL}	260 ± 5	O°

* Note: 1/10 duty cycle at 1KHz

Item	Symbol	Min.	Тур.	Max.	Unit
Optical Specifications					
CW Output Power *1	Po	250	-	350	mW
Peak Wavelength * ²	λ_{P}	395	400	405	nm
Viewing Angle	φ	140			deg.
Electrical Specifications					
Forward Current	I _F	-	350	-	mA
Forward Voltage *3	V _F	3.2	-	4.2	V

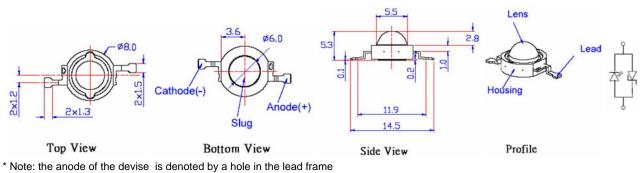
* Note:

1. Peak wavelength measurement allowance is $\pm 2 \text{ nm}$

2. Optical ouput measurement allowance is ± 10%

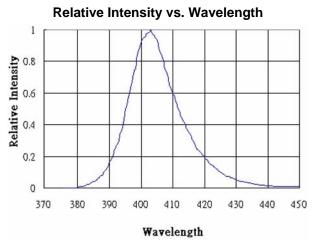
3. Forward voltage measurement allowance is \pm 0.2 V

Outline Dimensons (Unit: mm, Tolerance: ±0.2 mm)



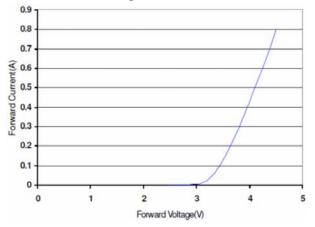


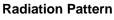
Typical Performance Curves

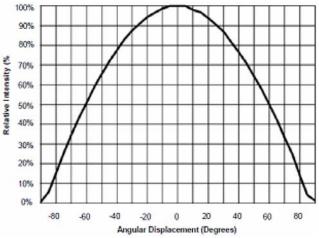


Forward Voltage vs. Forward Current 1.8 1.6 1.4 Relative 0.6 0.4 0.2 0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 0 Forward Ourrent(A)

Forward Voltage vs. Forward Current









Reliability

No.	Test Item	Test Conditions	Note	Sample	Pass
1	Room Temperature Operating Life	$T_a=25^{\circ}C, I_F=350mA$	1000 hrs.	20	ОК
2	Solder Heat Resistance	260±5°C, 5secs		20	ОК
3	High Temperature / High Humidity Operation Life	Ta=85°C, RH=85%, I _F =350mA	1000 hrs.	20	ОК
4	Temperature Cycle	-40°C … +105°C, 30 min dwell, 5 min transfer	200 Cycles	20	ОК
5	Themal Shock	-40°C +105°C, 20 min dwell, 20 sec transfer	200 Cycles	20	OK
6	High Temperature Storage	Tstg=120°C	1000 hrs.	20	ОК
7	Low Temperature Storage	Tstg=-40°C	1000 hrs.	20	ОК
8	Variable Vibration Frequency	10-2000-10Hz 20G 1 min, 1.5mm, 3timesx/axis		20	ОК
9	Mechanical Shock	1500G, 0.5msec pulse, 5 shocks each 6 axis		20	ОК
10	Natural Drop	On concrete from 1.2m, 3xtimes		20	OK

Conclusions:

- 1. The reliability tests were designed to evaluate both package integrity as well as workability of product performance over time.
- 2. All samples have done well by competed test required and passed all the qualification criteria with zero failure. From design standpoint, this package is robust enough to meet it's data sheet conditions.
- 3. Based on the food result shown on the above test, this product is qualified and released for market.

Precaution for Use

1. Cautions

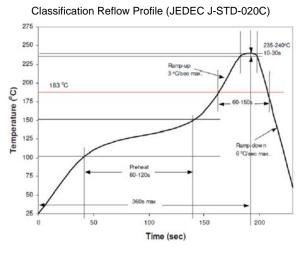
- This device is a UV LED, which radiates UV light during operation.
- DO NOT look directly into the UV light or look through the optical system. To prevent in adequate exposure of UV radiation, wear UV protective glasses.

2. Reflow Soldering Characteristics

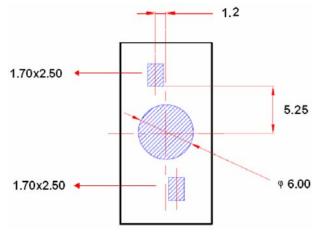
Profile Feature	Sn-Pd Eutectic Assembly	Lead(Pb)-Free Assembly
Average Ramp-Up Rate (T_{Smax} to T_P)	3°C / second max.	3°C / second max.
Preheat Temperature Min (T _{Smin})	100°C	150°C
Preheat Temperature Max (T _{smax})	150°C	200°C
Preheat Time (t _{smin} to t _{smax})	60-120 seconds	60-180 seconds
Time maintained above Temperature (T _L)	183°C	217°C
Time maintained above Time (t _L)	60-150 seconds	60-150 seconds
Peak / Classifivation Temperature (T _P)	240°C	260°C
Time Within 5°C of Actual Peak Temperature (t _p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C / second max.	6°C / second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



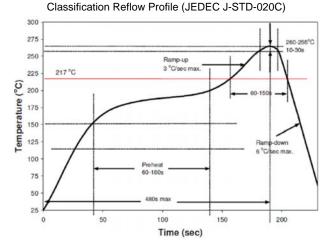
Lead Solder



Recommended Soldering Pattern



Lead-Free Solder



Note:

- Electrical isolation is required between Slug and solder Pad.
- For optimal thermal performance, macimize board metalization at heat slug contact.
- Reflow soldering should not be done more than one time.
- When soldering, do not put stress on the emitters during heating.
- After soldering, do not warp the circuit board

3. Static Electricity

- The LEDs are very sensitive to Static Electricity and surge voltage. So it is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be grounded properly. It is recommended that precautions should be taken against surge voltage to the equipment that mounts the LEDs.

4. Heat Generation

• The powered LEDs generate heat. Heat dissipation should be considered in the application design to avoid the environmental conditions for operation in excess of the absolute maximum ratings.